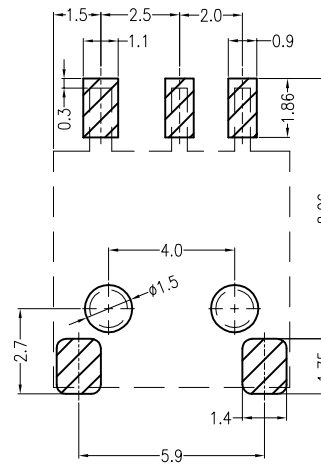
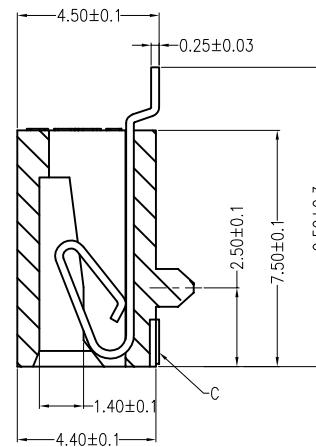
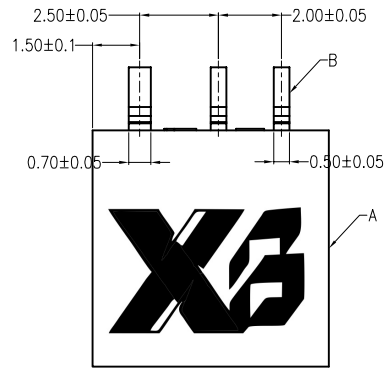
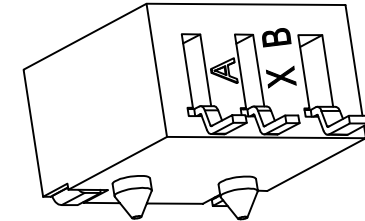


REV	DESCRIPTION	DESIGN	DATE
A0	Release	吴丹平	2016.04.30



Board Layout

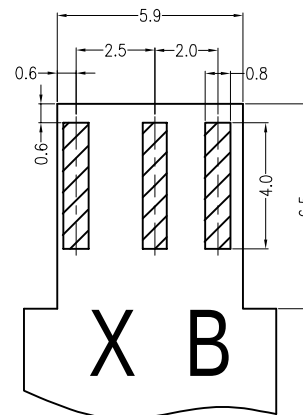
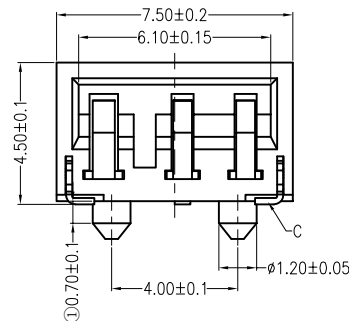


主要技术参数 Main Specifications

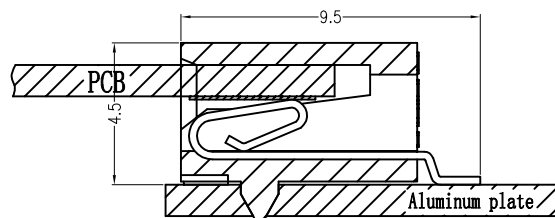
板 厚 (thickness): 1.0mm
 接触电阻 (Contact resistance): $\leq 20\text{m}\Omega$
 绝缘电阻 (Insulation resistance): $\geq 800\text{M}\Omega$
 额定电压 (Rated voltage): 250/150V AC DC
 额定电流 (Rated current): 1.0A AC DC
 耐 电 压 (Withstand Voltage): 1500V AC/minute
 温度范围 (Temperature Range): $-25^{\circ}\text{C} \sim +105^{\circ}\text{C}$

ORDER INFORMATION:

XB-L022-03-F2MB-R			
PART No.			
No. OF CIRCUITS:			PACKAGING:
03			R=REEL
PLASTIC MATERIAL:			P=PE
F2M=LCP (BEIGE)			PLATING:
			B=MATTE Sn



Mating Aluminum plate detail



Assembly Layout

C	Solder Tab	2 PCS	PhosphorBronze	MATTE Sn-plated
B	CONTACT	3 PCS	PhosphorBronze	MATTE Sn-plated
A	PEDESTAL	1 PCS	LCP	UL 94V-0, COLOR:BEIGE
ITEM	COMPONENT	Q'TY	MATERIAL	FINISH
东莞市溪榜电子有限公司 Switch Connector DONG GUAN XI BANG ELECTRONICS CO., LTD				
X.±0.5	X.±5°	USE:	CUSTOMER	
.X±0.3	.X±2°	APPD:	邵敬和	
.XX±0.25	.XX±1°	CHKD:	田峰	
--	--	DR:	蒋建银	
UNITS: mm		DR:	蒋建银	
TITLE: -			2.5/2.0mmPITCH 90°WAFER SMT TYPE	
PART NO.:			L022-03-F2MB-R	
DWG NO.:			GCCP-0041	
SCALE		SHEET		
1 : 1		1 / 1		